

DATA SHEET



BYD17 series General purpose controlled avalanche rectifiers

Product specification
Supersedes data of 1999 Nov 11

2001 Oct 26

General purpose
controlled avalanche rectifiers

BYD17 series

FEATURES

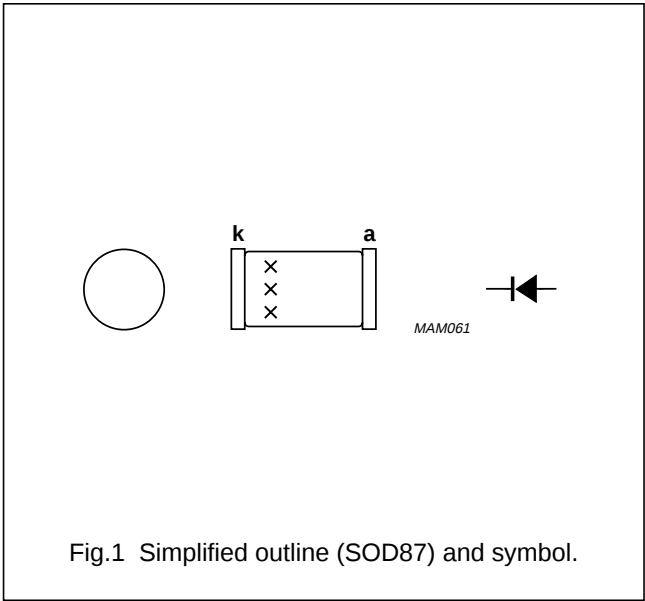
- Glass passivated
- High maximum operating temperature
- Low leakage current
- Excellent stability
- Guaranteed avalanche energy absorption capability
- Shipped in 8 mm embossed tape
- Smallest surface mount rectifier outline.

DESCRIPTION

Cavity free cylindrical glass package through Implotec™(1) technology.

This package is hermetically sealed and fatigue free as coefficients of expansion of all used parts are matched.

(1) Implotec is a trademark of Philips.



LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{RRM}	repetitive peak reverse voltage				
	BYD17D		–	200	V
	BYD17G		–	400	V
	BYD17J		–	600	V
	BYD17K		–	800	V
	BYD17M		–	1000	V
V _{RWM}	crest working reverse voltage				
	BYD17D		–	200	V
	BYD17G		–	400	V
	BYD17J		–	600	V
	BYD17K		–	800	V
	BYD17M		–	1000	V
V _R	continuous reverse voltage				
	BYD17D		–	200	V
	BYD17G		–	400	V
	BYD17J		–	600	V
	BYD17K		–	800	V
	BYD17M		–	1000	V

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SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$I_{F(AV)}$	average forward current	$T_{tp} = 105\text{ }^{\circ}\text{C}$; averaged over any 20 ms period; see Figs 2 and 4	–	1.5	A
		$T_{amb} = 65\text{ }^{\circ}\text{C}$; PCB mounting (see Fig.9); averaged over any 20 ms period; see Figs 3 and 4	–	0.6	A
I_{FSM}	non-repetitive peak forward current	$t = 10\text{ ms}$ half sinewave; $T_j = T_{j\text{ max}}$ prior to surge; $V_R = V_{RRMmax}$	–	20	A
E_{RSM}	non-repetitive peak reverse avalanche energy	$L = 120\text{ mH}$; $T_j = T_{j\text{ max}}$ prior to surge; inductive load switched off	–	7	mJ
T_{stg}	storage temperature		–65	+175	$^{\circ}\text{C}$
T_j	junction temperature	see Fig.5	–65	+175	$^{\circ}\text{C}$

ELECTRICAL CHARACTERISTICS

$T_j = 25\text{ }^{\circ}\text{C}$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_F	forward voltage	$I_F = 1\text{ A}$; $T_j = T_{j\text{ max}}$; see Fig.6	–	–	0.93	V
		$I_F = 1\text{ A}$; see Fig.6	–	–	1.05	V
$V_{(BR)R}$	reverse avalanche breakdown voltage	$I_R = 0.1\text{ mA}$				
			225	–	–	V
			450	–	–	V
			650	–	–	V
			900	–	–	V
			1100	–	–	V
I_R	reverse current	$V_R = V_{RRMmax}$; see Fig.7	–	–	1	μA
		$V_R = V_{RRMmax}$; $T_j = 165\text{ }^{\circ}\text{C}$; see Fig.7	–	–	100	μA
t_{rr}	reverse recovery time	when switched from $I_F = 0.5\text{ A}$ to $I_R = 1\text{ A}$; measured at $I_R = 0.25\text{ A}$; see Fig.10	–	3	–	μs
C_d	diode capacitance	$V_R = 0\text{ V}$; $f = 1\text{ MHz}$; see Fig.8	–	21	–	pF

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th\text{ j-tp}}$	thermal resistance from junction to tie-point		30	K/W
$R_{th\text{ j-a}}$	thermal resistance from junction to ambient	note 1	150	K/W

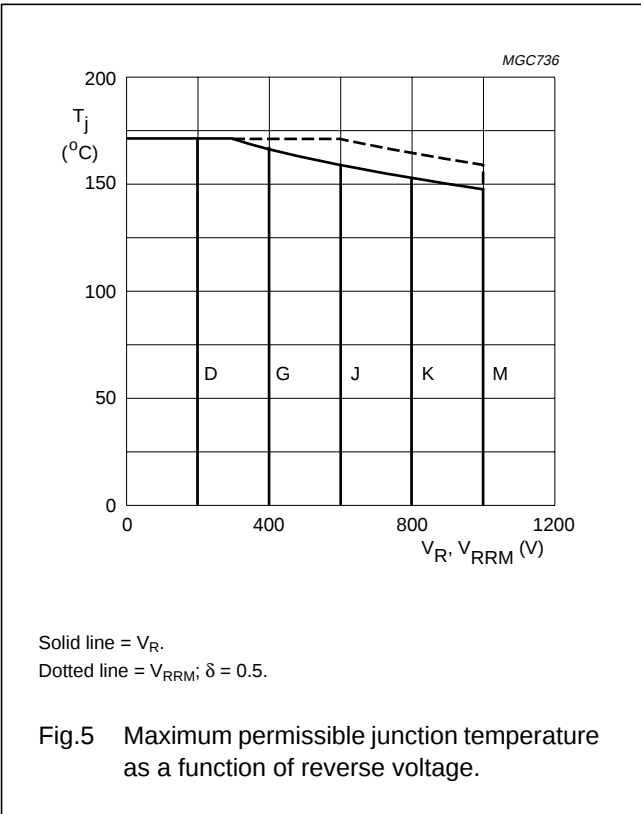
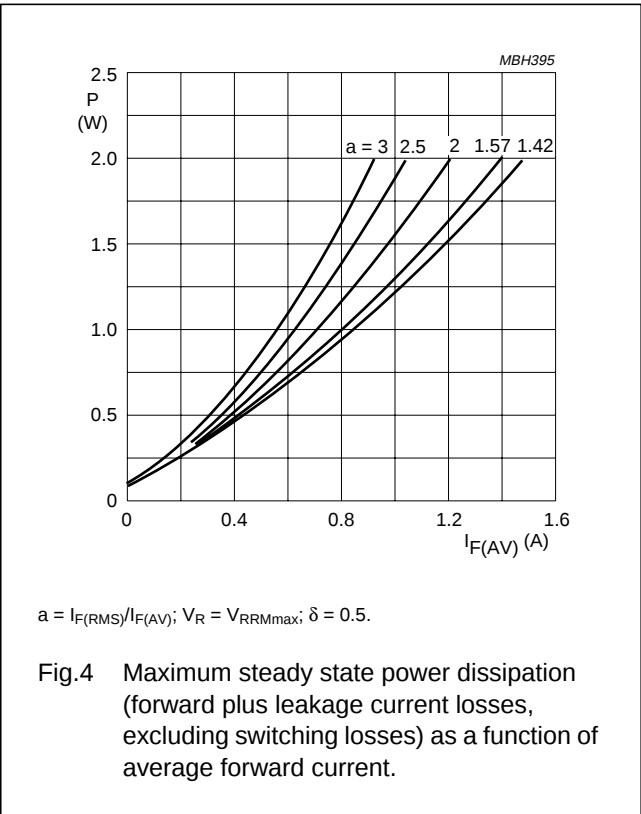
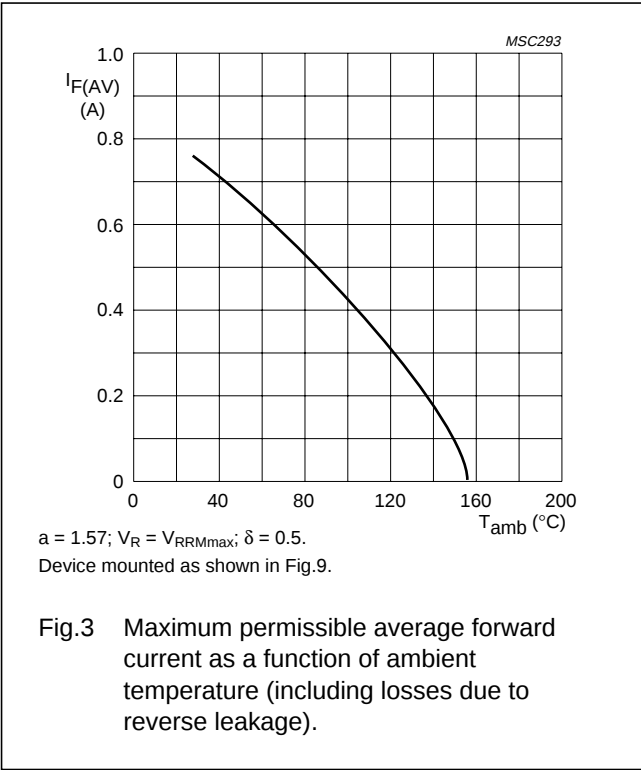
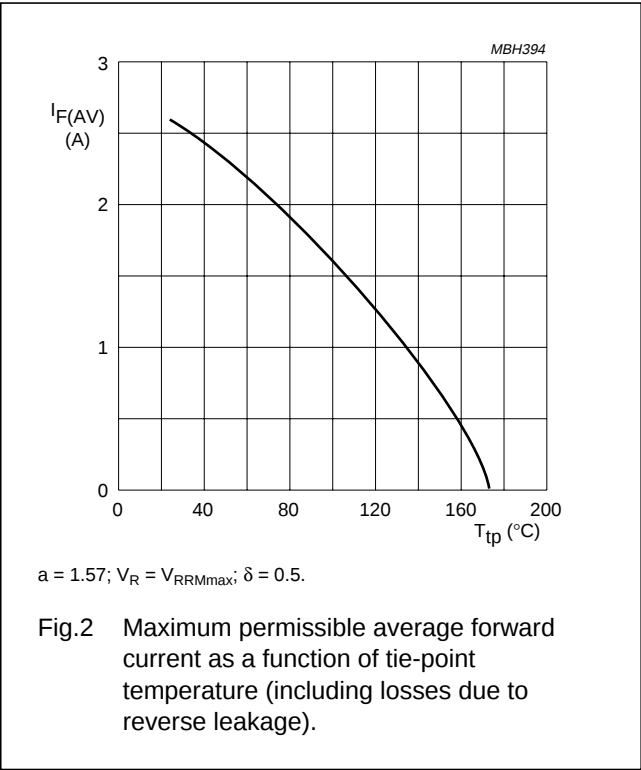
Note

1. Device mounted on epoxy-glass printed-circuit board, 1.5 mm thick; thickness of copper $\geq 40\text{ }\mu\text{m}$, see Fig.9.
For more information please refer to the “General Part of associated Handbook”.

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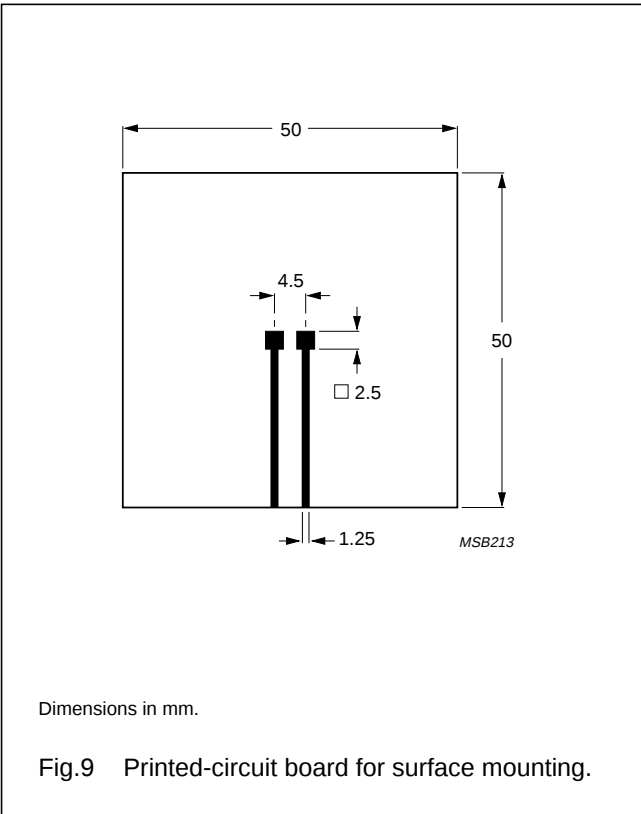
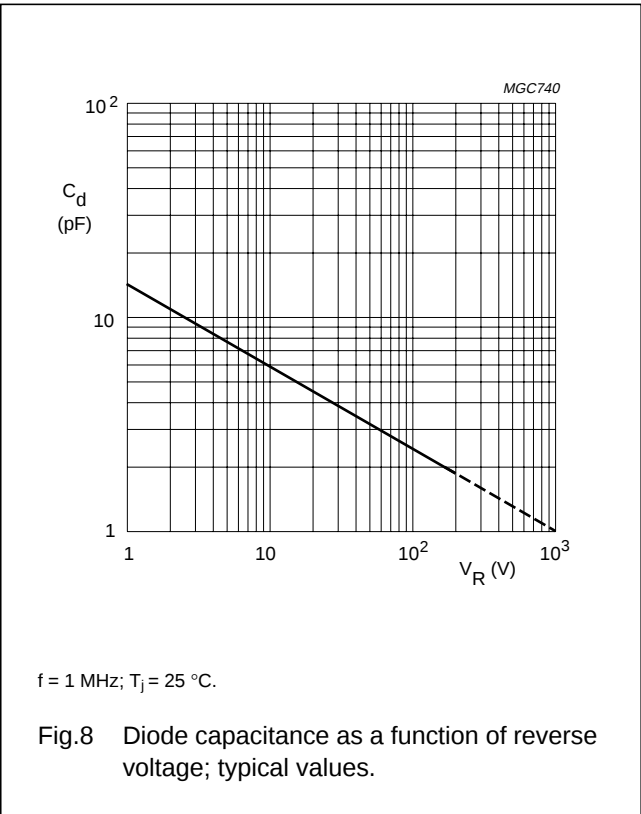
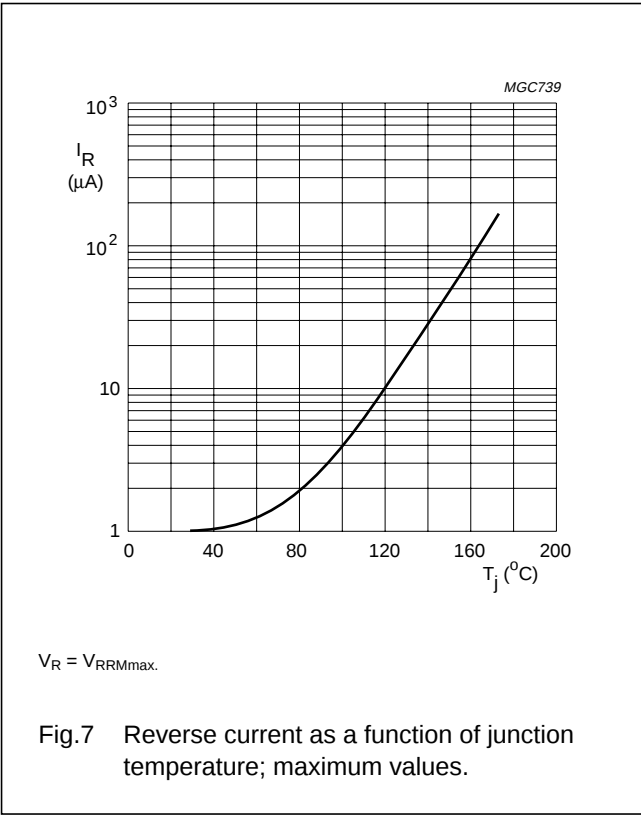
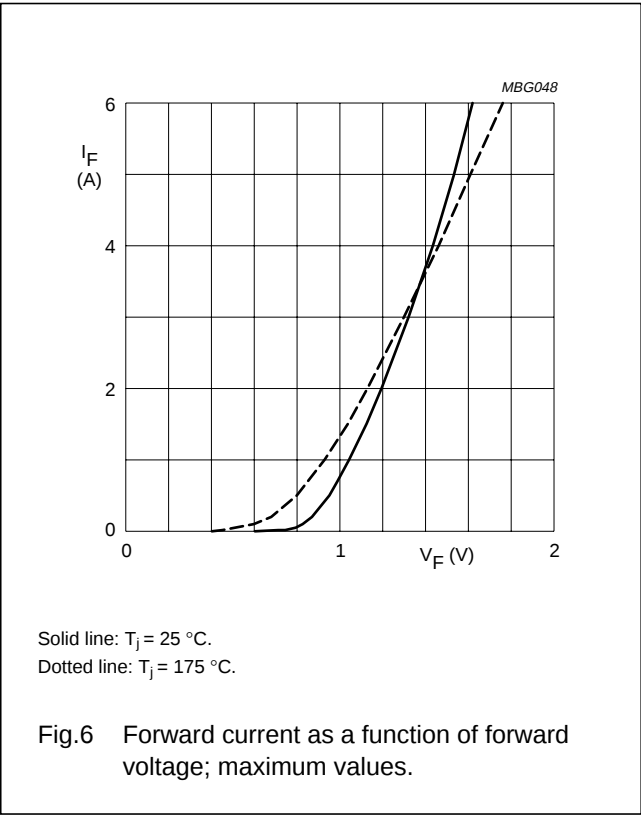
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GRAPHICAL DATA



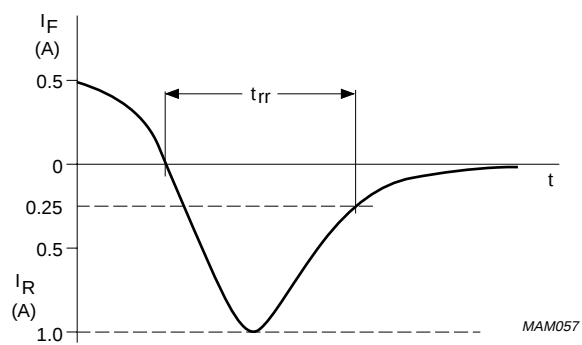
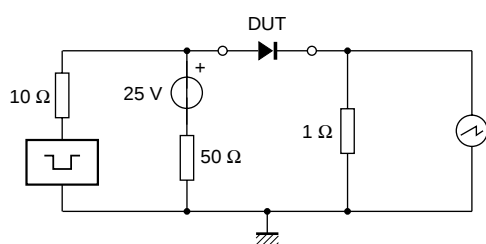
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Input impedance oscilloscope: 1 M Ω , 22 pF; $t_r \leq 7$ ns.
Source impedance: 50 Ω ; $t_r \leq 15$ ns.

Fig.10 Test circuit and reverse recovery time waveform and definition.

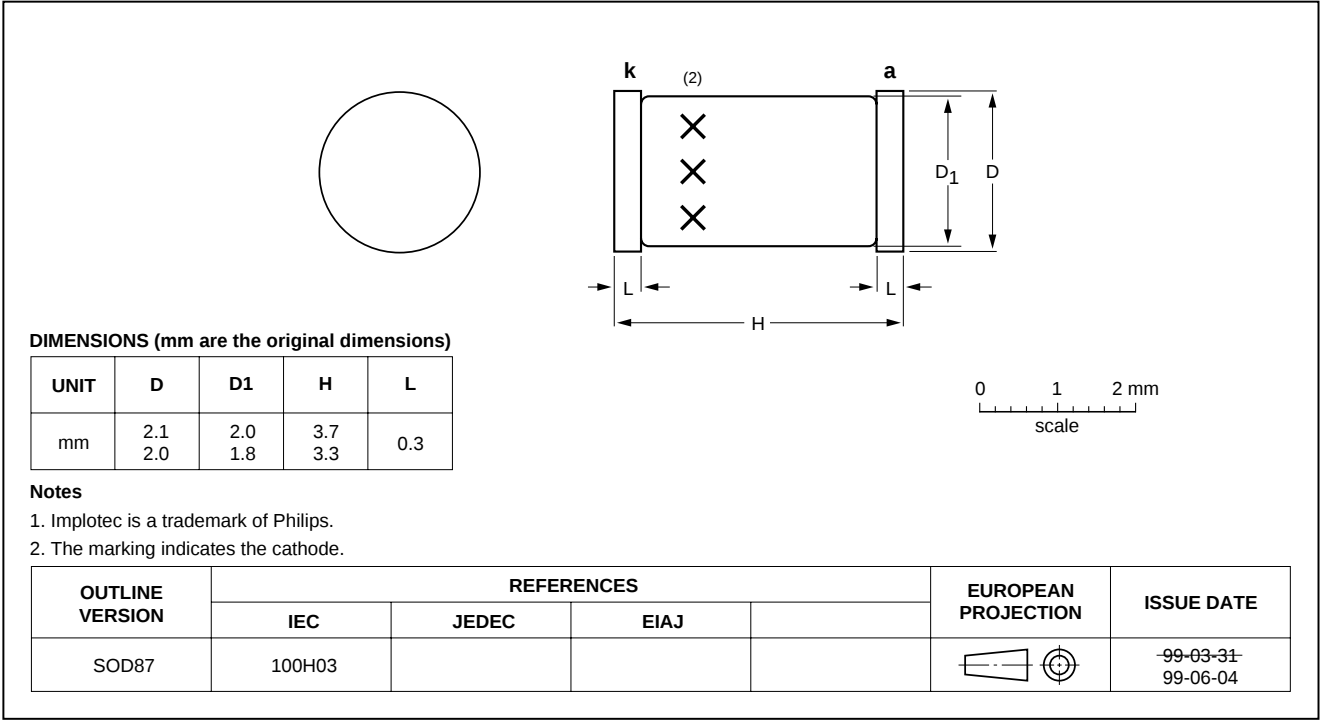
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PACKAGE OUTLINE

Hermetically sealed glass surface mounted package;
Implotec™⁽¹⁾ technology; 2 connectors

SOD87



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DATA SHEET STATUS

DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITIONS
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Printed in The Netherlands

613510/04/pp12

Date of release: 2001 Oct 26

Document order number: 9397 750 08864

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